

Express Mail No. EL629608964US  
PATENT  
36856.1162

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:  Tetsuya ODA et al.  Serial No.: Currently unknown  Filing Date: Concurrently herewith  For: METHOD OF FORMING THICK-FILM WIRING AND METHOD OF PRODUCING LAMINATED ELECTRONIC COMPONENT	
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**INFORMATION DISCLOSURE STATEMENT**

Mail Stop PATENT APPLICATION  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

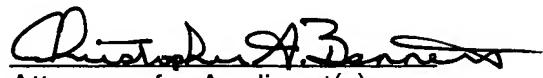
In accordance with 37 CFR §1.56, and in recognition of their duty to disclose to the United States Patent and Trademark Office relevant information known to be material to patentability, Applicants herewith submit copies of the prior art listed on the attached Information Disclosure Statement (Form PTO-1449), including an English abstract. The statement is not a representation that all of the information cited is necessarily effective as prior art against the application.

Information Disclosure  
Statement  
December 1, 2003  
Page 2 of 2

Applicants respectfully request that the disclosed references be made of record in the subject application.

Respectfully submitted,

Date: December 1, 2003

  
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Substitute for form 1449/PTO		Complete if Known	
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>(Use as many sheets as necessary)</i>		Application Number	
		Filing Date	
		First Named Inventor	<b>Tetsuya ODA</b>
		Art Unit	
		Examiner Name	
Sheet	1	of	1
		Attorney Docket Number	<b>36856.1162</b>

## U.S. PATENT DOCUMENTS

## FOREIGN PATENT DOCUMENTS

Examiner Signature		Date Considered	
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\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered, include copy of this form with next communication to applicant.

<sup>1</sup> Applicant unique citation designation number (optional).<sup>2</sup> See Kind Codes of USPTO Patent documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Abstract is attached.

This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14.